

Product Compliance Declaration

Please see <u>www.molex.com</u> for the most up-to-date information.

Contact Information						
Name	Molex Product Compliance	E-Mail	Product.Compliance@molex.com			
Part Inform	ation					
Part Number	0015910080	Part Weight	0.484629G			
Part Name	CGrid SMT Bkwy Hdr 15 SAu 8Ckt Tube					

Product Composition

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)
CGrid SMT Bkwy Hdr 15 SAu 8Ckt Tube	Assembly		100	0.484629
.440 X .0255 Sq Pin 15GOLD Plate	Assembly		66.0185	0.319945
.440 x .0255 Sq Bandolier Pin Unplated	Component		62.7284	0.304
Cartridge Brass 70% Unplated	Material		62.7284	0.304
Copper	Substance	7440-50-8	43.9099	0.2128
Zinc (metal)	Substance	7440-66-6	18.8185	0.0912
Gold Plating	Material		0.6038	0.002926
Cobalt	Substance	7440-48-4	0.0015	0.000007
Nickel	Substance	7440-02-0	0.0015	0.000007
Gold	Substance	7440-57-5	0.6008	0.002912
Nickel Plating	Material		1.8158	0.0088
Nickel	Substance	7440-02-0	1.8156	0.008799
Further Additives, not to declare	Substance	system	0.0002	9E-07

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Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)
Tin Plating	Material		0.8704	0.004218
Tin	Substance	7440-31-5	0.8704	0.004218
COMPONENT CGrid Bkwy Hsg 100Ckt	Component		33.9815	0.164684
LCP GF30 BLACK	Material		33.9815	0.164684
LCP	Substance		23.3453	0.113138
Carbon black	Substance	1333-86-4	0.3398	0.001647
GF-Fibre	Substance		10.1944	0.049405
Further Additives, not to declare	Substance	system	0.1019	0.000494

ROHS Declaration Information

Regulatory Revision EU 2015/863

Compliance Status Compliant

Contained Substances Exceeding Threshold

None

Exemptions

None

REACH-SVHC Declaration Information

Regulatory Revision D(2022)4187-DC (10 June 2022)

Contained Substances Exceeding Threshold

None

GADSL Declaration Information

Regulatory Revision GADSL imported from IMDS

Contained Substances Exceeding Threshold

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Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
	e-plate Sn (electrodeposited Tin Coatings, bright and matt)	*Note	500	Yes
Lead	Cartridge Brass 70% (CA260)	*Note	350	Yes
nickel	e-plate Au (Hardgold) (electrodeposited Hardgold	*Note	2,500	Yes
nickel	Ep-Ni	*Note	997,500	Yes
Cobalt	e-plate Au (Hardgold) (electrodeposited Hardgold	*Note	2,500	Yes
Copper	Cartridge Brass 70% (CA260)	*Note	700,000	Yes

*Note: For GADSL substance declarable/prohibited threshold values, please reference http://www.gadsl.org/

Exemptions

Part Name	Exemption
e-plate Sn (electrodeposited Tin Coatings, bright and matt)	44 Concentration within acceptable GADSL limits
Cartridge Brass 70% (CA260)	44 Concentration within acceptable GADSL limits
e-plate Au (Hardgold) (electrodeposited Hardgold Coatings)	34 Not applicable
Ep-Ni	33 Other application (Surface not routinely touched or nickel release rate < 0.5µg/ cm2/week)

HFLH Declaration Information

Regulatory Revision IEC 61249-2-21

Contained Substances Exceeding Threshold

None

China ROHS Declaration Information

Part Number	0015910080						
Part Name	CGrid SMT Bkwy Hdr 15 SAu 8Ckt Tube						
Part Information	on		Ha	zardous S	Substance	es	
Components		Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
CGrid SMT B	8kwy Hdr 15 SAu 8Ckt Tube	0	0	0	0	0	0
.440 X .0255	Sq Pin 15GOLD Plate	0	0	0	0	0	0

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Components	Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
.440 x .0255 Sq Bandolier Pin Unplated	0	0	0	0	0	0
COMPONENT CGrid Bkwy Hsg 100Ckt	0	0	0	0	0	0

Additional Information

Annex XVII to REACH (76/769/EEC)	Compliant
Regulation (EU) 2019/1021 (POP)	Compliant

Process Information

Component Plating / Surface Finish	MSn-Ni
Termination Base Alloy	Brass
Solder Alloy	N/A
Process Capability	REFLOW
Maximum Exposure Time (seconds)	005
Maximum Process Temperature (C)	260
Maximum Cycles at Reflow Temperature	001
J-STD-020 Moisture Sensitivity Level	N/A

Aug 19, 2022

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